Tyrone Camarero Specifications

Camarero DS400TR-18L

Key features

- · Data Center Optimized, Web Server, Enterprise Server, Managed Hosting, Short Depth
- 2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel® Xeon® Scalable Processors. Dual Socket P (LGA 3647) supported, CPU TDP support Up to 140W, 2 UPI up to 10.4 GT/s
- Intel @C621 chipset
- Up to 2TB 3DS ECC RDIMM, DDR4-2933MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-2933M Hz, in 8 DIMM slots
- 1 PCI-E 3.0 x8 (FHHL) slot
- 8 Hot-swap 2.5" SATA3 drive bays, 1 Slim DVD-ROM drive (optional), Optional PCIe/SATA M.2 drive
- 2 1GbE LAN ports via Marvell 88E1512
- IPMI 2.0 + KVM with Dedicated LAN
- 1 VGA, 2 USB 2.0 (rear)
- 2 SuperDOM (Disk on Module) ports; 1 PCIe/SATA M.2 drive connector

Processor/Cache		Front Panel	
Processor	2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel® Xeon® Scalable Processors.Dual Socket P (LGA 3647) supported, CPU TDP support Up to 140W, 2 UPI up to 10.4 GT/s	LED Indicators Buttons	Power status LED, HDD activity LED, Network activity LEDs, Universal Information (UID) LED Power On/Off button, System Reset button
Chipset		Drive Bays	
Chipset	Intel [®] C621 chipset	HDD Bays Peripheral Bays	8 Hot-swap 2.5" SATA3 drive bays 1 Slim DVD-ROM drive (optional), PCle/SATA M.2 drive (optional)
System Memory			
Memory Capacity	Up to 2TB 3DS ECC RDIMM, DDR4-2933 MHz; Up to 2TB 3DS ECC LRDIMM, DDR4-2933MHz, in 8 DIMM slots	Power Supply	
		600W High-Efficiency Power Supply Platinum Level Certified	
Expansion Slots			
PCI-Express 1 PCI-E 3.0 x8 (FHHL) slot		Cooling System	
		4x 4cm 22.5K RPM middle cooling fans	
ntegrated On-B	pard	Form Factor	
SATA	8 SATA3 (6Gbps) with RAID 0, 1, 5, 10	Form Factor	1U Rackmount
LAN	2 RJ45 Gigabit Ethernet LAN ports, 1 RJ45 Dedicated IPMI LAN port	Height : Width :	1.7* (43mm), 17.2" (437mm),
Add-on Options		Depth :	19.98" (508mm)
Raid Card	Optional	Email : info@tyronesystems.com	
Optical Drive	Optional	For more/current product information, visit www.tyronesystems.com	

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